



SPECIFICATION

(Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL31A476MQHNNWE

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 47 µF, 6.3V, ±20%, X5R, 1206

A. Samsung Part Number

<u>CL</u> <u>31</u> <u>A</u> <u>476</u> <u>M</u> <u>Q</u> <u>H</u> <u>N</u> <u>N</u> <u>W</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor		
2	Size	1206 (inch code)	L: 3.2 ± 0.2 mm W: 1.6 ± 0.2 mm	
3	Dielectric	X5R	8 Inner electrode Ni	
4	Capacitance	47 μF	Termination Cu	
(5)	Capacitance	±20 %	Plating Sn 100% (Pb Free)	
	tolerance		Product Normal	
6	Rated Voltage	6.3 V	Special Product for Network appropriate to the second sec	olication
7	Thickness	1.6 ± 0.2 mm	Packaging Embossed Type, 7"reel	

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition		
Capacitance	Within specified tolerance	120Hz ±20% 0.5±0.1Vrms *A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C, and maintained in ambient air		
Tan δ (DF)	0.1 max.	for 24±2 hours.		
Insulation	10,000Mohm or 100Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.		
Resistance	Whichever is Smaller			
Appearance No abnormal exterior appearance		Visual inspection		
Withstanding	No dielectric breakdown or	250% of the rated voltage		
Voltage mechanical breakdown				
Temperature	X5R			
Characteristics	(From -55℃ to 85℃, Capacitance change should be within ±15%)			
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.		
of Termination	terminal electrode			
Bending Strength	Capacitance change: within ±12.5%	Bending to the limit (1mm)		
		with 1.0mm/sec.		
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
	is to be soldered newly	245±5°C, 3±0.3sec.		
		(preheating : 80~120 ℃ for 10~30sec.)		
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5℃, 10±1sec.		
Soldering heat	Tan δ, IR : initial spec.			

	Performance	Test condition
Vibration Test	Capacitance change: within ±5%	Amplitude : 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture Capacitance change: within ±12.5%		With rated voltage
Resistance	Tan δ: 0.125 max	40±2°C, 90~95%RH, 500+12/-0hrs
	IR: 500Mohm or 12.5Mohm ⋅ μF	
	Whichever is Smaller	
High Temperature	Capacitance change : within ±12.5%	With 100% of the rated voltage
Resistance	Tan δ : 0.125 max	Max. operating temperature
	IR : 1,000Mohm or 25Mohm $\cdot \mu$ F	
	Whichever is Smaller	1000+48/-0hrs
Temperature	Capacitance change : within ±7.5%	1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperatur → 25 °C
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}$ C
		5 cycle test

C. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.